DATE: 08/11/2004

cosmo

ELECTRONICS CORPORATION

SMD LED:

KL-150UDX

NO. 61L30007

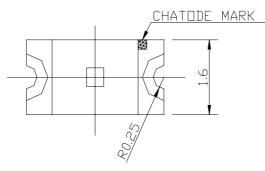
REV.

SHEET 1 OF 9

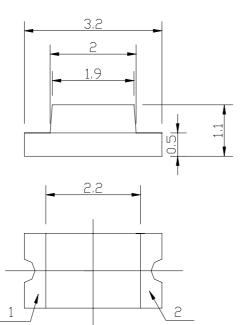
1

UNIT:MM

TOLERANCE: ±0.25







Part No.	Emitting Color	Material	Lens Type	(IF=20 MIN (mcd)	v 0mA) TYP (mcd)	Viewing Angle 2 θ 1/2
KL-150UDX	Super brightness orange	AlGaInP	Water Clear	30	65	120°

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Absolute maximum ratings (TA=25°C)		QE Orange (AlGaInP)	
Reverse voltage	VR	5	V
Forward current	IF	30	mA
Forward current(Peak)	IFP	100	
1/10 Duty Cycle,0.1ms Pulse Width			
Power dissipation Pd		50	
LED LAMPS:			
Operating temperature	Тор	-40~+85	${\mathbb C}$
Storage temperature	Tst	-40~+85	${\mathbb C}$
LED DISPLAYS:			
Operating temperature	TA	-40~+85	$^{\circ}$
Storage temperature	Tstg	-40~+85	$^{\circ}$

Operating characteristics (TA=25°C)		QE Orange (AlGaInP)	Unit
Forward voltage(typ.) IF=20mA	VF	2.4	V
Forward voltage(max.) IF=20mA	$\mathbf{V}_{\mathbf{F}}$	2.6	V
Reverse current(max.) V _R =5V	Ir	10	uA
Wavelength at dominant emission(typ.) IF=20mA	λь	620	nm
Wavelength at peak emission(typ.) IF=20mA	λР	630	nm
Spectral line half-width IF=20mA	Δλ	20	nm
Capacitance V _F =0V,f=1MHz	C	25	pF

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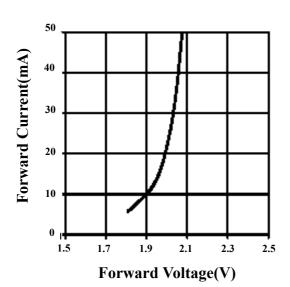
KL-150UDX

NO.61L30007

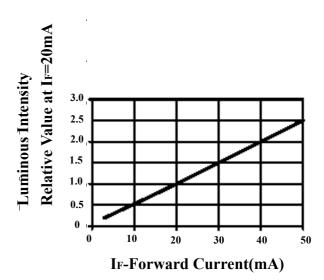
REV.

SHEET 3 OF 9

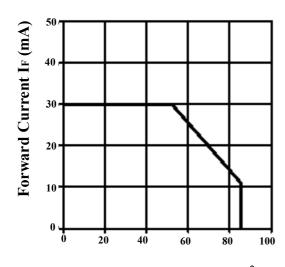
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Forward Current Vs. Forward Voltage

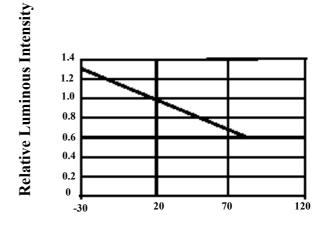


Luminous Intensity Vs. Forward Current



Ambient Temperature T_A(°C)

Forward Current Derating Curve



Ambient Temperature T_A(°C)

Luminous Intensity Vs. Ambient Temperature

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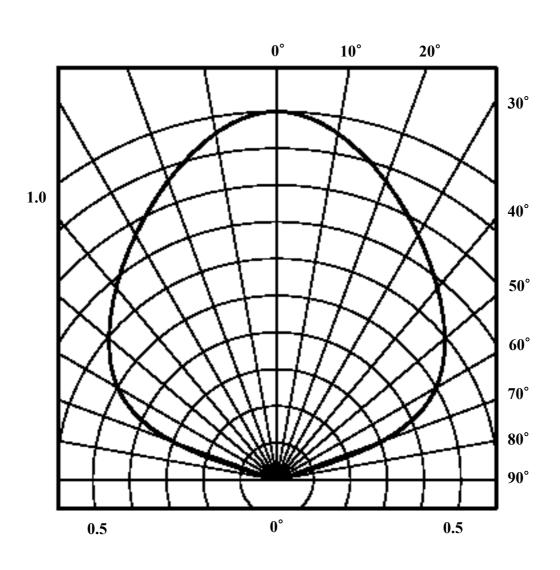
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View Angle 2 *∂* 1/2=120°

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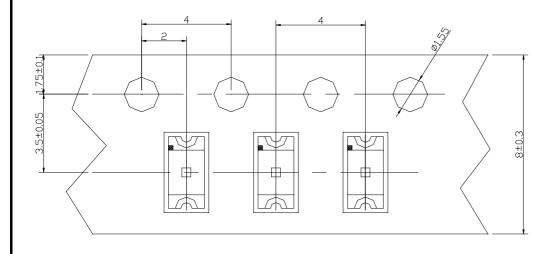
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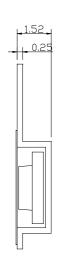
UNIT:MM

TOLERANCE: ±0.25

TYPE PACKAGE:2000 OR 1000PCS/REEL

REEL.TT":14mmTYP





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SMD LED:

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REV.

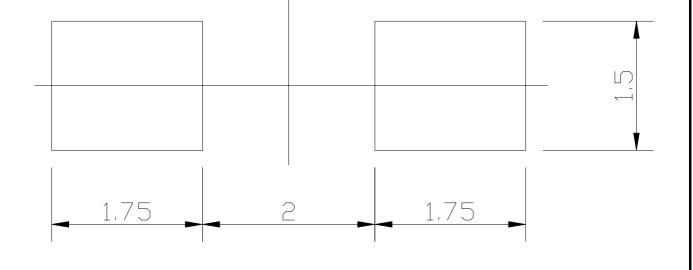
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1

UNIT:MM

The following soldering patterns are recommended for reflow-soldering:

For reflow soldering



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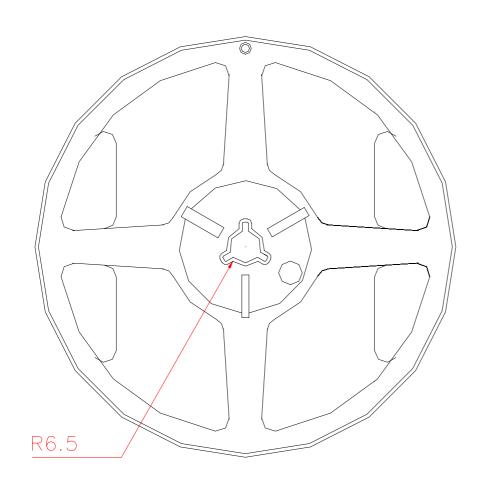
REV.

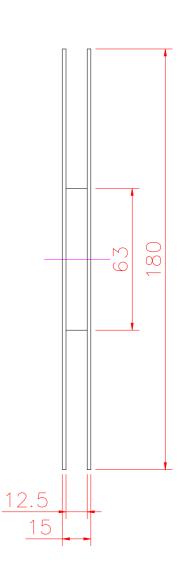
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1

UNIT:MM

TOLERANCE: ±0.25





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SMD LED:

KL-150UDX

NO. 61L30007

REV.

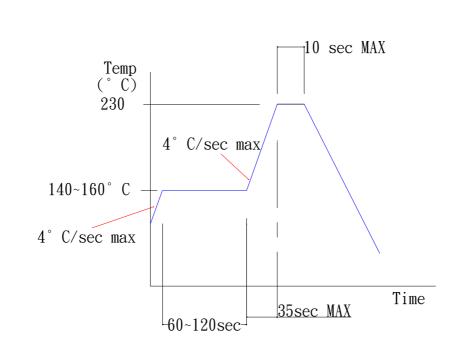
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SOLDERING

SMT REFLOW SOLDERING INSTRUCTIONS





SOLDERING INSRTUCTIONS							
TYPES	DIP AND WAVE SOLDERING			IRON SOLDERING(WITH 1.5mm IRON TIP)			
	TEMPERATURE OF THE SOLDERING BATH	MAXLMUM SOLDERING TIME	DISTANCE FORM SOLDER JOINT TO CASE	TEMPERATURE OF SOLDERING IRON	MAXLMUM SOLDERING TIME	DISTANCE FROM SOLDER JOINT TO CASE	
LEDS	≦260 ℃	3S	>2mm	≦260 °C	3S	>2mm	
	≦260 ℃	5S	>4mm	≦260 °C	5S	>4mm	
DISPLAYS	≦260 ℃	3S	>2mm	≦260 ℃	3S	>2mm	

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SMD HANDLING AND APPLICATION PRECAUTIONS

STORAGE

(1.1)It is recommended to store the devices in accordance with the following conditions:

Humidity: 60%RH Max.

Temperature: $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ ($41^{\circ}\text{F} \sim 86^{\circ}\text{F}$)

(1.2)Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and <30%RH. After the package is opened, the products should be used within 72hrs. Or they should be kept at $\leq 20\%\text{RH}$ in zip -locked sealed bags.

DRY PACK AND BAKING

SMD LEDs are MOISTURE SENSITIVE devices. Avoid absorbing moisture at any time during transportation and/or storage. It is recommended to bake before soldering when the pack is unsealed after 72 hrs, or any suspicious moisture being found. Bake devices in accordance with the following conditions:

- (a) $60\pm3^{\circ}$ C x (12~24hrs) and <5%RH, taped reel type
- (b) $100\pm3^{\circ}$ C x (45min~1hr), loose packing type, or
- (c) $130\pm3^{\circ}$ C x (15~30min), loose packing type

ELECTRIC STATIC DISCHARGE(ESD) PROTECTION

Materials with GaN, InGaN, AlInGaP are STATIC SENSITIVE devices. They will be packed in anti-static bags. ESD protection must be deliberatively observed from the initial design stage. The static -electric discharge may result in severe malfunction of the devices. In the events of manual working in process, make sure the devices are well protected from ESD at any time. Surge before and during handling products.